DATA SHEET

| Part No. | AN18164B | |
|------------------|-----------------|--|
| Package Code No. | LQFP048-P-0707A | |

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AN18164B

Car Radio FM/AM tuner IC built-in PLL synthesizer

Overview

AN18164B is Car Radio FM/AM tuner IC built-in PLL synthesizer.

This IC is enable to adjust and change over various function by I^2C -bus, and AM up-conversion system and FM IF detection coil-less system reduce the number of parts.

■ Feature

- I²C-bus control
- Built-in PLL synthesizer
- AM up-conversion system
- IF detection coil-less

Application

• Car radio

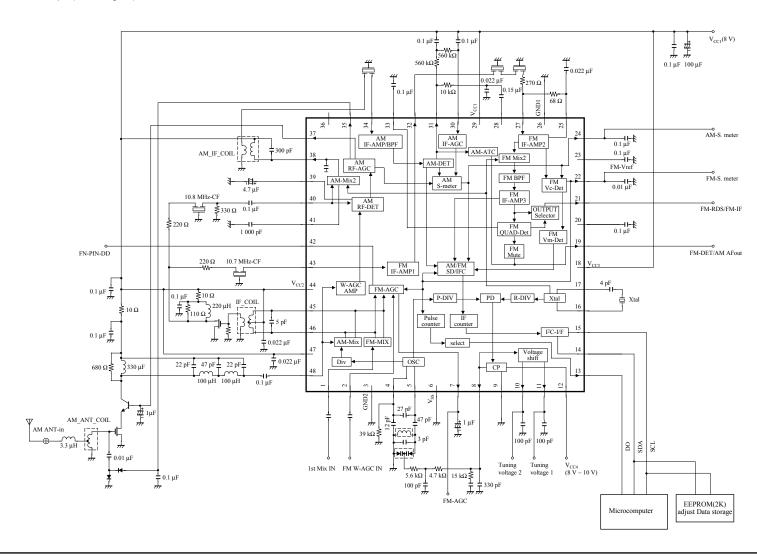
■ Package

• 48pin Plastic Low Profile Quad Flat Package (QFP type)

■ Type

• Bi-CMOS IC

■ Application Circuit Example (Block Diagram)



■ Pin Descriptions

| Pin No. | Node Name | Type | Function | | |
|---------|----------------|--------------|--|--|--|
| 1 | FM-MIX1IN | Input | FM-1st. Mix IN | | |
| 2 | FM-WAGCIN | Input | FM Wide Band AGC Detection | | |
| 3 | GND2 | Ground | RF-GND | | |
| 4 | L-OSC1 | _ | Local Oscillator Resonance load 1 | | |
| 5 | L-OSC2 | _ | Local Oscillator Resonance load 2 | | |
| 6 | VSS | Ground | VSS(Logic-GND) | | |
| 7 | FM-AGCOUT | Output | FM-AGC Output | | |
| 8 | CPOUT | Output | Charge pump Output | | |
| 9 | GND3 | Ground | PLL-GND | | |
| 10 | PTCOUT | Output | Tuning Voltage Adjust 2 | | |
| 11 | PTBOUT | Output | Tuning Voltage Adjust 1 | | |
| 12 | VCC4 | Power Supply | PLL-V _{CC} | | |
| 13 | SDOUT | Output | SD/monitor Output | | |
| 14 | SDA | Input | Serial Data Input(SDA) | | |
| 15 | SCL | Input | Serial Clock Signal Input(SCL) | | |
| 16 | X-OSC1 | _ | Crystal Oscillation 1 | | |
| 17 | X-OSC2 | _ | Crystal Oscillation 2 | | |
| 18 | VCC3 | Power Supply | Logic-V _{CC} | | |
| 19 | DETOUT | Output | AM/FM Detection Output | | |
| 20 | FM-MUTE-TC | _ | FM Mute Time constant setup | | |
| 21 | FM-RDSOUT | Output | FM Detection Output | | |
| 22 | AMFM SMETER | Output | FM Control Voltage/AM Signal Meter | | |
| 23 | FM-VREF | _ | FM-Vref | | |
| 24 | FM-BMUTE-TC | Output | FM Band Mute time constant setup/AM Signal Meter | | |
| 25 | FM-IF1-BY-PASS | _ | FM 1st IF Bypass capacitor | | |
| 26 | GND1 | Ground | IF-GND | | |
| 27 | FM-IF1IN2 | Input | FM 1st IF IN | | |
| 28 | AM-ATCIN | Input | AM ATC IN | | |
| 29 | VCC1 | Power Supply | V _{CC} | | |
| 30 | AM-IFAGCIN | Input | AM IFAGC Control | | |
| 31 | AM-DETOUT | Output | AM Detection Output | | |
| 32 | FM-IF1OUT | Output | FM 1st IF Output | | |
| 33 | FM-DET-BY-PASS | _ | FM Detection Bypass capacitor | | |
| 34 | AM-IFIN | Input | AM IF IN | | |
| 35 | AM-PINDD | Output | AM PIN diode driver | | |

■ Pin Descriptions (continued)

| Pin No. | Node Name | Туре | Function | | | |
|---------|-------------|--------------|------------------------------|--|--|--|
| 36 | N.C. | _ | Non connected | | | |
| 37 | AM-RFGC | _ | AM-RF Gain Control | | | |
| 38 | AM-MIX2OUT | Output | AM-2nd Mixer Output | | | |
| 39 | AM-AGC | _ | AM-RFAGC Level Detector | | | |
| 40 | AM-MIX2IN | Input | AM-2nd Mix IN | | | |
| 41 | AM-MIX2VREF | _ | AM 2nd Mix Reference Voltage | | | |
| 42 | FM-PINDD | Output | FM PIN diode driver | | | |
| 43 | FM-IF1IN | Input | FM 1st IF IN | | | |
| 44 | VCC2 | Power Supply | $RF-V_{CC}$ | | | |
| 45 | MIXOUT1 | Output | AM/FM-1st Mix Out 1 | | | |
| 46 | MIXOUT2 | Output | AM/FM-1st Mix Out 2 | | | |
| 47 | VCC2 | Power Supply | L-OSC V _{CC} | | | |
| 48 | AM-MIX1IN | Input | AM-1st Mix IN | | | |

■ Absolute Maximum Ratings

| A No. | Parameter | Symbol | Rating | Unit | Note |
|------------------|-------------------------------|------------------|-------------|------|------|
| 1 | 1 Corol William | V _{CC1} | 8.7 | V | *1 |
| 1 Supply Voltage | Supply Voltage | V _{CC2} | 11.1 | | |
| 2 | Supply Current | I _{CC} | 70 | mA | _ |
| 3 | Power dissipation | P_{D} | 293.6 | mW | *2 |
| 4 | Operating ambient temperature | T _{opr} | -40 to +85 | °C | *3 |
| 5 | Storage temperature | T_{stg} | -55 to +150 | °C | *3 |

Note) *1: Show the case to be used in the situation less than absolute maximum rating and power dissipation.

*2 : Power dissipation is value in simple package and $T_a = 85$ °C.

*3 : Ta = 25°C except storage temperature, operating ambient temperature and power dissipation.

■ Operating supply voltage range

| Parameter | Symbol | Rating | Unit | Note |
|----------------------|------------------|-------------|------|------|
| C and a thorough | V _{CC1} | 7.2 to 8.6 | 3.7 | _ |
| Supply voltage range | V _{CC2} | 7.2 to 11.0 | | * |

Note) *: Show the case to be used in the situation less than absolute maximum rating and power dissipation.

■ Allowable Voltage Ranges

| Pin No. | Pin name | Range | Unit | Notes |
|---------|-------------------|-----------|------|-------|
| 12 | V _{CC} 4 | 0 to 11.0 | V | _ |
| 13 | SDOUT | 0 to 5.5 | V | _ |
| 14 | SDA | 0 to 5.5 | V | _ |
| 15 | SCL | 0 to 5.5 | V | _ |
| 18 | V _{CC} 3 | 0 to 8.6 | V | _ |
| 29 | V _{CC} 1 | 0 to 8.6 | V | _ |
| 44 | V _{CC} 2 | 0 to 8.6 | V | _ |
| 47 | V _{CC} 2 | 0 to 8.6 | V | _ |

Note) 1. The ranges on the list are the voltages of respective pins in relation to GND.

The GND represents the voltage of GND1,GND2,GND3, and VSS. And GND1=GND2=GND3=VSS.

2. Do not apply the voltages or the currents from external into the pins which are not on the list.

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